

# STLD125N4F6AG

# Automotive-grade N-channel 40 V, 2.4 mΩ typ., 120 A STripFET™ F6 Power MOSFET in a PowerFLAT™ 5x6 DSC

Datasheet - production data

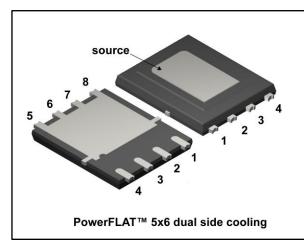
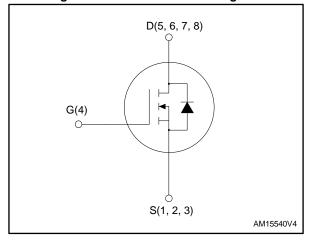


Figure 1: Internal schematic diagram



### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	ID
STLD125N4F6AG	40 V	$3.0~\text{m}\Omega$	120 A



- AEC-Q101 qualified
- Very low on-resistance
- Very low gate charge
- High avalanche ruggedness
- Low gate drive power loss
- Wettable flank package

### **Applications**

• Switching applications

### Description

This device is an N-channel Power MOSFET developed using the STripFET  $^{\text{TM}}$  F6 technology with a new trench gate structure. The resulting Power MOSFET exhibits very low R<sub>DS(on)</sub> in all packages.

**Table 1: Device summary** 

Order code	Marking	Package	Packaging
STLD125N4F6AG	125	PowerFLAT™ 5x6 dual side cooling	Tape and reel

Contents STLD125N4F6AG

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STLD125N4F6AG Electrical ratings

# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	40	V
V <sub>GS</sub>	Gate-source voltage	±20	٧
I <sub>D</sub> <sup>(1)(2)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	120	Α
I <sub>D</sub> <sup>(2)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C	101	Α
I <sub>DM</sub> <sup>(2)(3)</sup>	Drain current (pulsed)	480	Α
P <sub>TOT</sub> <sup>(2)</sup>	Total dissipation at T <sub>C</sub> = 25 °C	130	W
TJ	Operating junction temperature range	FF to 17F	°C
T <sub>stg</sub>	Storage temperature range	-55 to 175	

#### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-c</sub> top side	Thermal resistance junction-case top side	3.0	
Rthj-c bottom side	Thermal resistance junction-case bottom side	1.14	°C/W
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb	31.3	

#### Notes:

**Table 4: Avalanche characteristics** 

Symbol	Parameter	Value	Unit
I <sub>AV</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by maximum junction temperature)	90	Α
E <sub>AS</sub>	Single pulse avalanche energy ( $T_j = 25$ °C, $I_C = I_{AV}$ , $V_{DD} = 16$ V)	150	mJ

<sup>&</sup>lt;sup>(1)</sup>Limited by package.

 $<sup>\</sup>ensuremath{^{(2)}}\xspace$  The value is rated according to  $R_{thj\text{-}case\ bottom\ side}.$ 

 $<sup>\</sup>ensuremath{^{(3)}}\mbox{Pulse}$  width limited by safe operating area.

 $<sup>^{(1)}</sup>$ When mounted on 1 inch² 2 Oz. Cu board, t ≤ 10 s

Electrical characteristics STLD125N4F6AG

### 2 Electrical characteristics

(T<sub>C</sub>= 25 °C unless otherwise specified)

Table 5: On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	40			>
	Zoro goto voltago Droin	$V_{GS} = 0 \text{ V}, V_{DS} = 16 \text{ V}$			1	μΑ
IDSS	Zero gate voltage Drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 16 \text{ V},$ $T_j = 125 \text{ °C}^{(1)}$			10	μΑ
I <sub>GSS</sub>	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	2.5		3.5	V
D	Static drain-source	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 75 A		2.4	3.0	mΩ
R <sub>DS(on)</sub>	on-resistance	$V_{GS} = 6.5 \text{ V}, I_D = 75 \text{ A}$		3.0	4.0	11122

#### Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	5600	1	pF
Coss	Output capacitance	V <sub>DS</sub> = 10 V, f = 1 MHz,	-	890	-	pF
Crss	Reverse transfer capacitance	Ves = 0 V	-	560	-	pF
Qg	Total gate charge	$V_{DD} = 32 \text{ V}, I_D = 75 \text{ A},$	-	91	-	nC
Qgs	Gate-source charge	V <sub>GS</sub> = 0 to 10 V (see Figure 14: "Test circuit for gate charge	-	28	1	nC
$Q_{gd}$	Gate-drain charge	behavior")	-	27	-	nC

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 30 \text{ V}, I_D = 75 \text{ A},$	-	47	-	ns
t <sub>r</sub>	Rise time	$R_G = 30 \Omega$ , $V_{GS} = 10 V$ (see Figure 13: "Test circuit for	-	300	-	ns
t <sub>d(off)</sub>	Turn-off-delay time	resistive load switching times"	-	255	-	ns
<b>t</b> f	Fall time	and Figure 18: "Switching time waveform")	-	220	-	ns

 $<sup>^{(1)}</sup>$ Defined by design. Not subject to production test.

Table 8: Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub> <sup>(1)</sup>	Source-drain current		-		120	Α
I <sub>SDM</sub> <sup>(2)</sup>	Source-drain current (pulsed)		-		480	Α
V <sub>SD</sub> (3)	Forward on voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 90 A	-		1.2	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 90 A, di/dt = 100 A/μs,	-	40		ns
Qrr	Reverse recovery charge	V <sub>DD</sub> = 20 V (see Figure 15: "Test circuit for inductive load	-	41		nC
I <sub>RRM</sub>	Reverse recovery current	switching and diode recovery times")	-	2		Α

#### Notes:

<sup>(1)</sup>Limited by package

 $<sup>\</sup>ensuremath{^{(2)}}\mbox{Pulse}$  width is limited by safe operating area.

 $<sup>^{(3)}\</sup>text{Pulse}$  test: pulse duration = 300  $\mu\text{s},$  duty cycle 1.5%

# 2.1 Electrical characteristics (curves)

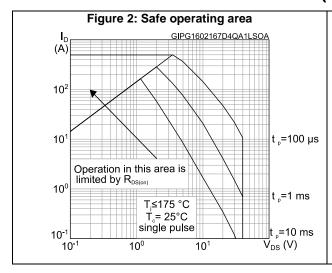
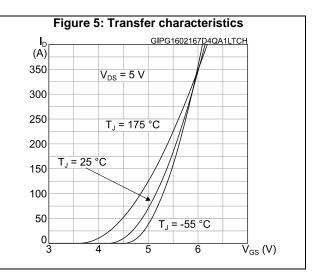
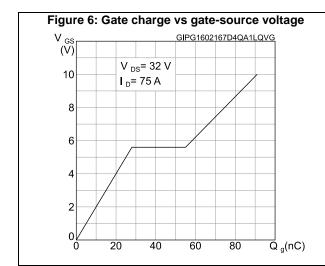


Figure 3: Thermal impedance  $K = \frac{10^{-2}}{\delta = 0.5}$   $\delta = 0.5$   $\delta = 0.02$   $Z_h = K^* R_{thjc} \text{ bottom side } \delta = tp/T$   $\frac{10^{-2}}{10^{-5}}$   $10^{-4}$   $10^{-3}$   $10^{-2}$   $10^{-2}$   $10^{-2}$   $10^{-2}$   $10^{-2}$   $10^{-4}$   $10^{-3}$   $10^{-2}$   $10^{-1}$   $10^{-2}$ 





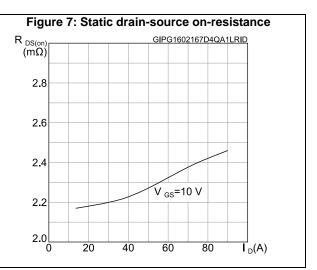


Figure 8: Capacitance variations

C GIPG1602167D4QA1LCVR

C CISS

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C COSS

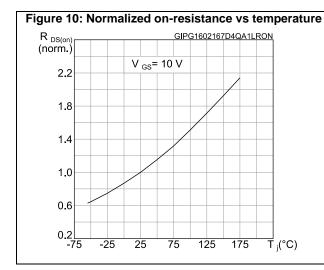
F = 1 MHz
V<sub>os</sub> = 0 V

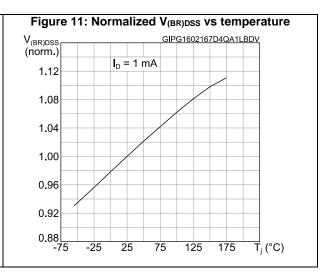
C CRSS

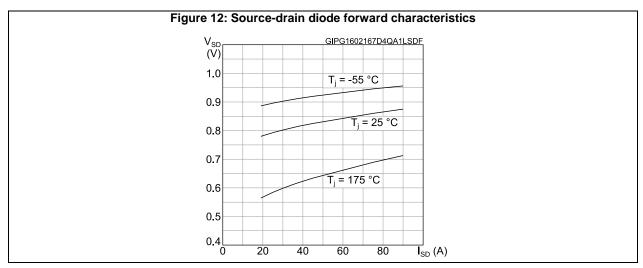
102

0 10 20 30 V<sub>DS</sub> (V)

Figure 9: Normalized gate threshold voltage vs temperature V<sub>GS(th)</sub> (norm.) GIPG1602167D4QA1LVTH I<sub>D</sub>= 250 μA 1.2 1.0 8.0 0.6 -25 25 75 125 175 T<sub>i</sub>(°C)







Test circuits STLD125N4F6AG

### 3 Test circuits

Figure 13: Test circuit for resistive load switching times

Figure 14: Test circuit for gate charge behavior

12 V 47 KΩ 100 Ω D.U.T.

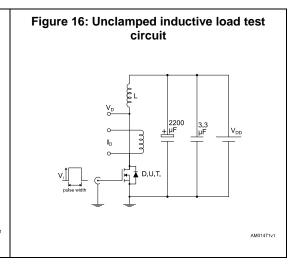
12 V 47 KΩ VGD

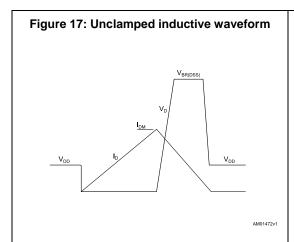
14 V CONST 100 Ω VGD

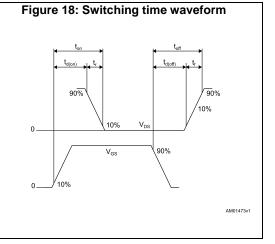
15 V CONST 100 Ω VGD

AM01469v1

Figure 15: Test circuit for inductive load switching and diode recovery times







# 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

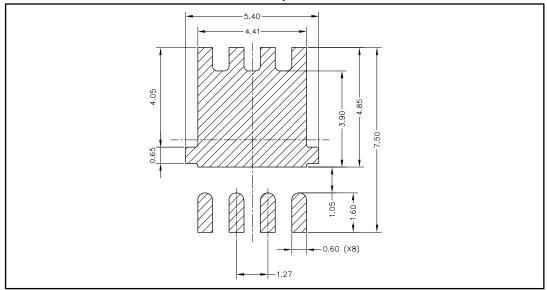
### 4.1 PowerFLAT™ 5x6 dual side cooling package information

Figure 19: PowerFLAT™ 5x6 dual side cooling package outline BOTTOM VIEW Ļ SIDE VIEW D3 र्शको) D Plated Area Εđ E3 TOP VIEW 8548760\_2

Table 9: PowerFLAT™ 5x6 dual side cooling mechanical data

		mm	
Dim.	Min.	Тур.	Max.
А	0.66	0.71	0.76
A1	0.60		0.75
b	0.33	0.43	0.53
С	0.15	0.203	0.30
D		5.00 BSC	
D1	4.06	4.21	4.36
D2		2.40 BSC	
D3	2.80	3.30	3.80
E		6.00 BSC	
E1	3.525	3.675	3.825
E2	1.05	1.20	1.35
E3		3.80 BSC	
E4	4.20	4.70	5.20
е		1.27 BSC	
I			0.15
L	0.15	0.25	0.35
L1	0.925	1.05	1.175
L2	0.45	0.575	0.70
θ		12° BSC	
ϑ1		7° BSC	
j		0.20 BSC	

Figure 20: PowerFLAT™ 5x6 dual side cooling recommended footprint (dimensions are in mm)



STLD125N4F6AG Package information

# 4.2 PowerFLAT™ 5x6 dual side cooling packing information

Figure 21: PowerFLAT™ 5x6 dual side cooling tape (dimensions are in mm)

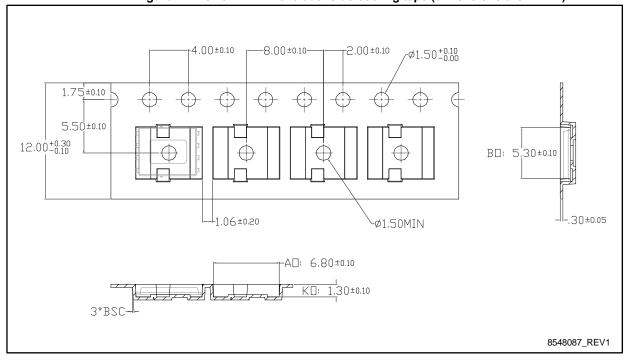
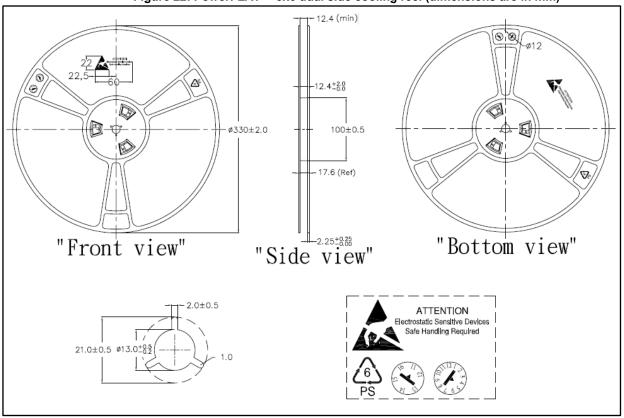


Figure 22: PowerFLAT™ 5x6 dual side cooling reel (dimensions are in mm)



Revision history STLD125N4F6AG

# 5 Revision history

Table 10: Document revision history

Date	Revision	Changes
16-Feb-2016	1	First release.
07-Feb-2017	2	Document status promoted from preliminary to production data.  Updated <i>Table 3: "Thermal data"</i> and <i>Table 5: "On/off states"</i> .  Minor text changes.
23-Feb-2017	3	Updated features on cover page. Updated Table 5: "On/off states" and Figure 9: "Normalized gate threshold voltage vs temperature". Minor text changes
12-Jul-2017	4	Added Section 4.2: "PowerFLAT™ 5x6 dual side cooling packing information".

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